

- NOTES:
- MATERIAL:
    - 1.1) PLASTIC:LCP BLACK
    - 1.2) TERMINAL:C5210,T=0.10±0.02
    - 1.3) SHELL:MATERIAL:SUS304,T=0.20±0.02
  - TERMINAL PLATING:
    - 2-1:TERMINAL: CONTACT AREA:GOLD PLATING  
SOLDER AREA:GOLD FLASH  
UNDER PLATING:NICKEL 50u" Min.
    - 2-2:SHELL: NO PLATING
  - PART MUST COMPLY TAISOL HF WD-3-I-091 SPECIFICATION

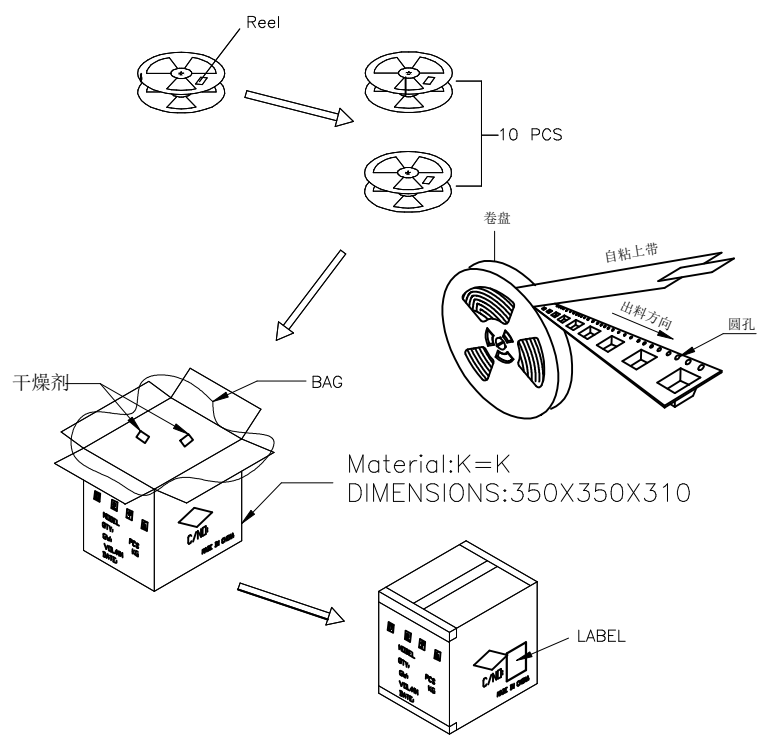
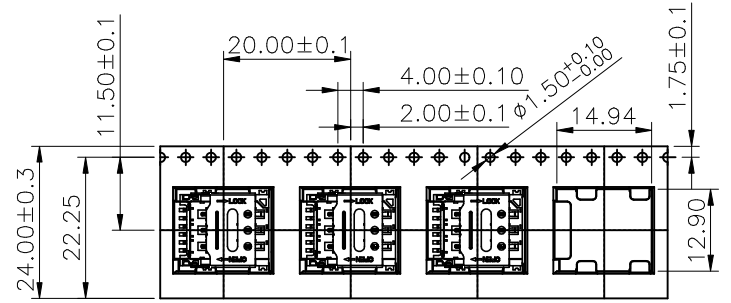
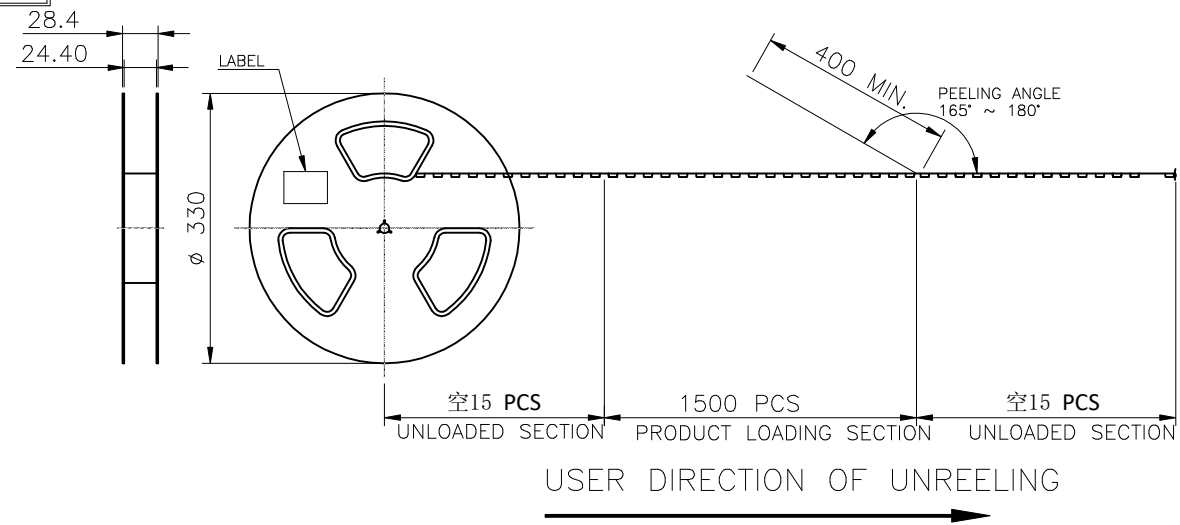
PART.NO.: SP172-AN401-\*\*\*

- 08: 功能区镀金1U", 锡脚Gold Flash
- 09: 功能区镀金3U", 锡脚Gold Flash
- 10: 功能区镀金5U", 锡脚Gold Flash
- 11: 功能区镀金15U", 锡脚Gold Flash
- 12: 功能区镀金30U", 锡脚Gold Flash

PIN NO.	PIN NAME	PIN TYPE
C1	VCC	Power
C2	RST	
C3	CLK	
C5	GND	Power
C6	VPP	
C7	I/O	Bidirectional

RECOMMENDED PCB LAYOUT  
TOLERANCE ±0.05  
SMT SOLDER AREA

GENERAL TOLERANCE		DWG.NO.	SP172-AN401-00	PART.NO.	SP172-AN401-***	DRAWN	Huang 2019.09.16
x.±0.50	x.*± 5°	REV.	A	TITLE	Nano SIM H1.40掀盖式	CHECKED	
.x±0.25	.x*± 2°	SIZE		SHEET	1 OF 2	APPROVED	
.xx±0.15	.xx± 1°	A4					



NOTE:

- MATERIAL:
  - BOX: FIBREBOARD, CORRUGATED, DOUBLE WALL.
  - COVER TAPE: PET, HEAT-RESISTANT TEMPERATURE: 100°C, TRANSPARENT COLOR.
  - CARRIER TAPE: POLYSTYRENES, HEAT-RESISTANT TEMPERATURE: 120°C, BLACK COLOR.
  - REEL: POLYSTYRENES, HEAT-RESISTANT TEMPERATURE: 70°C, BLUE COLOR.
  - BAG: POLYETHYLENE, HEAT-RESISTANT TEMPERATURE: 100°C.
- PEELING STRENGTH: 0.1 ~ 1.3 N (10 ~ 130 GRAMS)
- PEELING SPEED: 300 mm/min.
- EACH BAG SHALL BE INCLUDED DESICCANT.

1500	10	15000
PCS/REEL	REEL/BOX	TOTAL Q'TY

GENERAL TOLERANCE	DWG.NO.	SP172-AN401-00	PART.NO.	SP172-AN401-**	DRAWN	Huang 2019.09.16
x.±0.50	REV.	A	TITLE	Nano SIM H1.40掀盖式	CHECKED	
.x±0.25	SIZE		SHEET	2 OF 2	APPROVED	
.xx±0.15	A4					

UNIT	mm	SCALE	1:1
<b>东莞市欧联电子科技有限公司</b> DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.			